

Single P-channel MOSFET

ELM14405AA-N

■General description

ELM14405AA-N uses advanced trench technology to provide excellent $R_{ds(on)}$, low gate charge and low gate resistance.

■Features

- $V_{ds}=-30V$
- $I_d=-6A$ ($V_{gs}=-10V$)
- $R_{ds(on)} < 50m\Omega$ ($V_{gs}=-10V$)
- $R_{ds(on)} < 85m\Omega$ ($V_{gs}=-4.5V$)

■Maximum absolute ratings

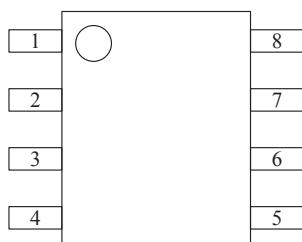
Parameter	Symbol	Limit	Unit	Note
Drain-source voltage	V_{ds}	-30	V	
Gate-source voltage	V_{gs}	± 20	V	
Continuous drain current Ta=25°C	I_d	-6.0	A	1
Ta=70°C		-5.1		
Pulsed drain current	I_{dm}	-30	A	2
Power dissipation Ta=25°C	P_d	3.0	W	1
Ta=70°C		2.1		
Junction and storage temperature range	T_j, T_{stg}	-55 to 150	°C	

■Thermal characteristics

Parameter		Symbol	Typ.	Max.	Unit	Note
Maximum junction-to-ambient	$t \leq 10s$	$R_{\theta ja}$	31	40	°C/W	1
Maximum junction-to-ambient	Steady-state		59	75	°C/W	
Maximum junction-to-lead	Steady-state	$R_{\theta jl}$	16	24	°C/W	3

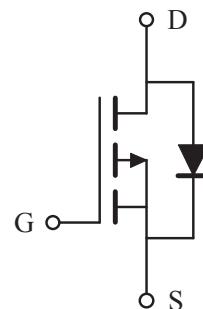
■Pin configuration

SOP-8(TOP VIEW)



Pin No.	Pin name
1	SOURCE
2	SOURCE
3	SOURCE
4	GATE
5	DRAIN
6	DRAIN
7	DRAIN
8	DRAIN

■Circuit



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■Electrical characteristics

T_a=25°C

Parameter	Symbol	Condition		Min.	Typ.	Max.	Unit	
STATIC PARAMETERS								
Drain-source breakdown voltage	BVdss	Id=-250µA, Vgs=0V		-30			V	
Zero gate voltage drain current	Idss	Vds=-24V, Vgs=0V	T _j =55°C			-1	µA	
						-5		
Gate-body leakage current	Igss	Vds=0V, Vgs=±20V				±100	nA	
Gate threshold voltage	Vgs(th)	Vds=Vgs, Id=-250µA		-1.0	-1.8	-3.0	V	
On state drain current	Id(on)	Vgs=-10V, Vds=-5V		-30			A	
Static drain-source on-resistance	Rds(on)	Vgs=-10V, Id=-6A	T _j =125°C		40	50	mΩ	
					55	70		
		Vgs=-4.5V, Id=-4A			65	85	mΩ	
Forward transconductance	Gfs	Vds=-5V, Id=-6A		6.0	9.5		S	
Diode forward voltage	Vsd	Is=-1A, Vgs=0V			-0.78	-1.00	V	
Max. body-diode continuous current	Is					-4.2	A	
DYNAMIC PARAMETERS								
Input capacitance	Ciss	Vgs=0V, Vds=-15V, f=1MHz			700	840	pF	
Output capacitance	Coss				112		pF	
Reverse transfer capacitance	Crss				78		pF	
Gate resistance	Rg	Vgs=0V, Vds=0V, f=1MHz			10	15	Ω	
SWITCHING PARAMETERS								
Total gate charge (10V)	Qg	Vgs=-10V, Vds=-15V, Id=-6A			14.7	18.0	nC	
Total gate charge (4.5V)	Qg				7.6		nC	
Gate-source charge	Qgs				2.0		nC	
Gate-drain charge	Qgd				3.8		nC	
Turn-on delay time	td(on)	Vgs=-10V, Vds=-15V Rl=2.5Ω, Rgen=3Ω			8.6		ns	
Turn-on rise time	tr				5.0		ns	
Turn-off delay time	td(off)				28.2		ns	
Turn-off fall time	tf				13.5		ns	
Body diode reverse recovery time	trr		If=-6A, dl/dt=100A/µs		24.0	30.0	ns	
Body diode reverse recovery charge	Qrr	If=-6A, dl/dt=100A/µs			14.7		nC	

NOTE :

1. The value of R_{θja} is measured with the device mounted on 1in² FR-4 board of 2oz. Copper, in still air environment with T_a=25°C. The value in any given applications depends on the user's specific board design. The current rating is based on the t ≤ 10s thermal resistance rating.
2. Repetitive rating, pulse width limited by junction temperature.
3. The R_{θja} is the sum of the thermal impedance from junction to lead R_{θjl} and lead to ambient.
4. The static characteristics in Figures 1 to 6 are obtained using 80µs pulses, duty cycle 0.5%max.
5. These tests are performed with the device mounted on 1in² FR-4 board with 2oz. Copper, in a still air environment with T_a=25°C. The SOA curve provides a single pulse rating.



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■ Typical electrical and thermal characteristics

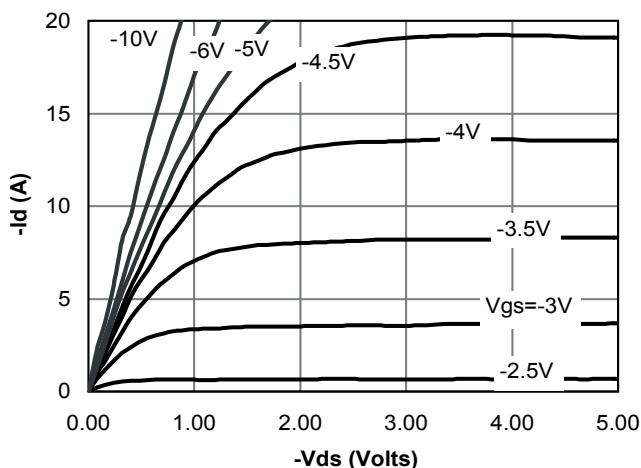


Figure 1: On-Region Characteristics

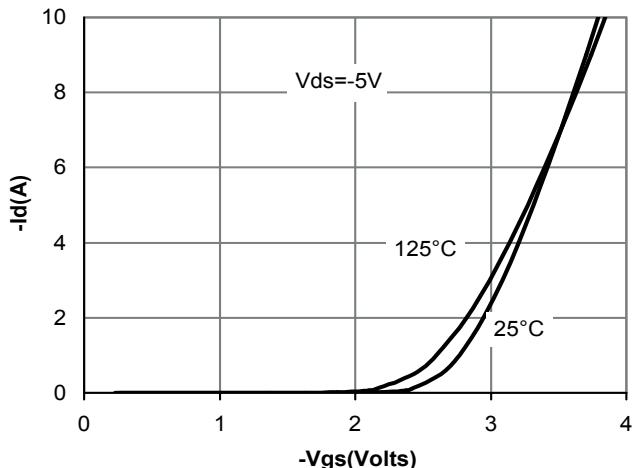


Figure 2: Transfer Characteristics

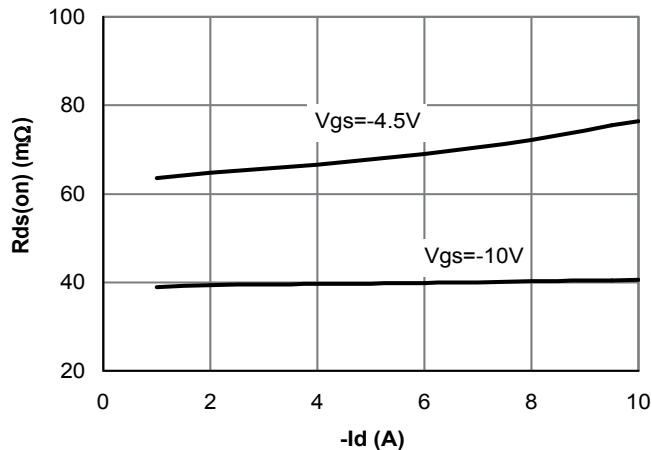


Figure 3: On-Resistance vs. Drain Current and Gate Voltage

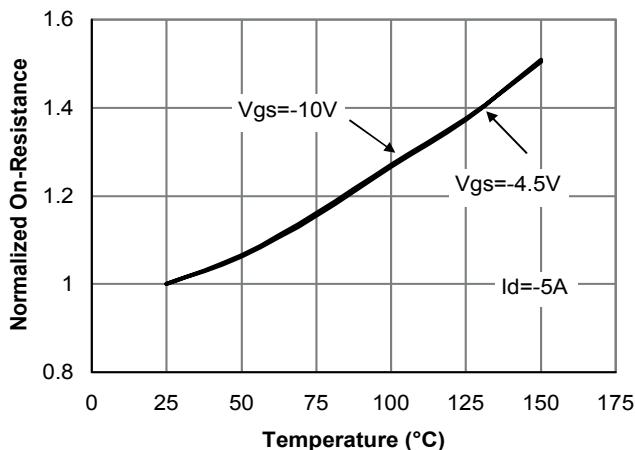


Figure 4: On-Resistance vs. Junction Temperature

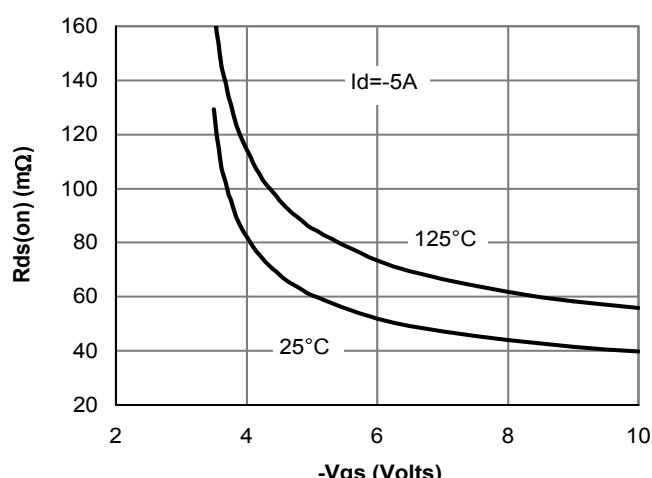


Figure 5: On-Resistance vs. Gate-Source Voltage

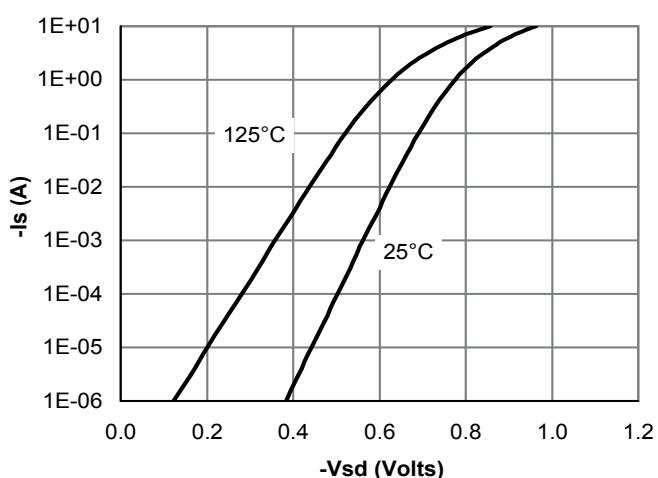


Figure 6: Body-Diode Characteristics

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